



## Product Change Notification - SYST-16WNGM772

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**Date:**

26 Nov 2018

**Product Category:**

16-Bit - Microcontrollers and Digital Signal Controllers

**Affected CPNs:****Notification subject:**

ERRATA - dsPIC33CH512MP508 Family Silicon Errata and Data Sheet Clarification

**Notification text:**

SYST-16WNGM772

Microchip has released a new DeviceDoc for the dsPIC33CH512MP508 Family Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at [dsPIC33CH512MP508 Family Silicon Errata and Data Sheet Clarification](#).

**Notification Status:** Final

**Description of Change:** Initial version of this document; issued for revision A0.

**Impacts to Data Sheet:** None

**Reason for Change:** To Improve Productivity

**Change Implementation Status:** Complete

**Date Document Changes Effective:** 26 Nov 2018

**NOTE:** Please be advised that this is a change to the document only the product has not been changed.

**Markings to Distinguish Revised from Unrevised Devices:** N/A

**Attachment(s):**

[dsPIC33CH512MP508 Family Silicon Errata and Data Sheet Clarification](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

DSPIC33CH512MP508-E/PT

DSPIC33CH512MP508-I/PT

DSPIC33CH512MP508T-I/PT

## dsPIC33CH512MP508 Family Silicon Errata and Data Sheet Clarification

The dsPIC33CH512MP508 family devices that you have received conform functionally to the current Device Data Sheet (DS70005371B), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in [Table 1](#). The silicon issues are summarized in [Table 2](#).


The errata described in this document will be addressed in future revisions of the dsPIC33CH512MP508 silicon.

**Note:** This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of [Table 2](#) apply to the current silicon revision (A0).

Data Sheet clarifications and corrections start on [Page 7](#), following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate website ([www.microchip.com](http://www.microchip.com)).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

1. Using the appropriate interface, connect the device to the hardware debugger.
2. Open an MPLAB IDE project.
3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
4. Based on the version of MPLAB IDE you are using, do one of the following:
  - a) For MPLAB IDE 8, select *Programmer > Reconnect*.
  - b) For MPLAB X IDE, select *Window > Dashboard* and click the **Refresh Debug Tool Status** icon (  ).
5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

**Note:** If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various dsPIC33CH512MP508 silicon revisions are shown in [Table 1](#).

**TABLE 1: SILICON DEVREV VALUES**

Part Number	Device ID <sup>(1)</sup>	Revision ID for Silicon Revision
		A0
Devices with CAN FD		
dsPIC33CH256MP505	0x7D42	0x0000
dsPIC33CH512MP505	0x7D52	
dsPIC33CH256MP506	0x7D43	
dsPIC33CH512MP506	0x7D53	
dsPIC33CH256MP508	0x7D44	
dsPIC33CH512MP508	0x7D54	
Devices With No CAN FD		
dsPIC33CH256MP205	0x7D02	0x0000
dsPIC33CH512MP205	0x7D12	
dsPIC33CH256MP206	0x7D03	
dsPIC33CH512MP206	0x7D13	
dsPIC33CH256MP208	0x7D04	
dsPIC33CH512MP208	0x7D14	

**Note 1:** The Device IDs (DEVID and DEVREV) are located at the last two implemented addresses of configuration memory space. They are shown in hexadecimal in the format "DEVID DEVREV".

# dsPIC33CH512MP508

**TABLE 2: SILICON ISSUE SUMMARY**

Module	Feature	Item Number	Issue Summary	Affected Revisions
				A0
I <sup>2</sup> C	Interrupt	1.	In Slave mode, incorrect interrupt generated with DHEN = 1.	X
I <sup>2</sup> C	Error	2.	False bus collision error generated.	X
I <sup>2</sup> C	Idle	3.	SFRs are reset in Idle mode.	X
I <sup>2</sup> C	SMBus 3.0	4.	When Configuration bit, SMBEN (FDEVOP<10>) = 1, the SMBus 3.0 VIH minimum specification may not be met.	X
Oscillator	HS, XT	5.	The Primary Oscillator Start-up Timer (OST) may indicate the oscillator is ready for use too early.	X
PWM	Dead Time	6.	When feed-forward PCI is used for dead-time compensation (DTCMPSEL = 1), the PWMx outputs are overridden.	X
UART	FERR	7.	The FERR bit will not get set if one Stop bit is received.	X
UART	OERR	8.	The 9th byte received will not be available to be read.	X
UART	TXWRE	9.	TXWRE bit (UxSTAH<7>) cannot be cleared once it gets set.	X
UART	Address Detect	10.	When writing to UxP1 with UTXBRK = 1, content of P1 will not get transmitted.	X
UART	Address Detect	11.	In Address Detect mode, content of P1 is not transmitted on writing to P1 with UTXBRK = 1.	X
UART	Sleep	12.	When waking from Sleep with a UART reception, SLPEN needs to be set in addition to WAKE = 1.	X
UART	Smart Card	13.	Wait time interrupt flag is set when the last character transmitted has the bit, LAST = 0.	X
MBIST	MBISTDONE	14.	After executing a Reset, the MBISTDONE bit will always be set.	X
CPU	FLIM Instruction	15.	When the operands are of different signs, the FLIM instruction may not force the correct data limit.	X
CPU	MAXAB/MINAB Instructions	16.	When the operands are of different signs, the MAXAB, MINAB and MINZAB instructions may not output the correct value.	X
CPU	div.sd Instruction	17.	When using the signed 32-by-16-bit division instruction, div.sd, the Overflow bit is not getting set when an overflow occurs.	X
CPU	Byte Mode Instructions	18.	When using Byte mode instructions, the upper byte of the destination register may not be persistent.	X
SCCP/MCCP	Clock Source	19.	Using Fosc as the clock source may cause synchronization issues.	X
I/O	POR	20.	Spike on I/O at POR.	X

## Silicon Errata Issues

**Note:** This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**A0**).

### 1. Module: I<sup>2</sup>C

In Slave mode with DHEN = 1 (Data Hold Enable), if software sends a NACK, a Slave interrupt is asserted at the 9th falling edge of the clock.

#### Work around

Software should ignore the Slave interrupt that is asserted after sending a NACK.

#### Affected Silicon Revisions

A0							
X							

### 2. Module: I<sup>2</sup>C

In Slave mode, a false bus collision event is generated when the bus collision is enabled (SBCDE = 1) and a Stop bit is received.

#### Work around

None.

#### Affected Silicon Revisions

A0							
X							

### 3. Module: I<sup>2</sup>C

In Slave mode, the SFRs are reset when the device is in Idle and the module is set for discontinuous in Idle (I2CSIDL = 1).

#### Work around

None.

#### Affected Silicon Revisions

A0							
X							

### 4. Module: I<sup>2</sup>C

When selecting SMBus 3.0 operation using Configuration bit, SMBEN (FDEVOT<10>), the Voltage Input High (V<sub>IH</sub>) of the SMBus 3.0 specification minimum may not be met.

#### Work around

None.

#### Affected Silicon Revisions

A0							
X							

### 5. Module: Oscillator

The Primary Oscillator Start-up Timer (OST) may indicate the oscillator is ready for use too early. Clocking the device before the oscillator is ready may result in incorrect execution and exceptions. This issue exists when the POSC is requested at power-on, during clock switching, when waking from Sleep or when a peripheral module requests the POSC directly. This issue affects XT and HS modes only.

#### Work around

Make sure that the Primary Oscillator clock is ready before using it by following these steps:

1. Running on a non-POSC source, request the POSC clock using a peripheral such as REFO.
2. Provide a delay to stabilize the POSC.
3. Then switch to the POSC source.

#### Affected Silicon Revisions

A0							
X							

### 6. Module: PWM

When feed-forward PCI is used for dead-time compensation (DTCMPSEL = 1), the PWMx outputs are overridden.

#### Work around

Use Sync PCI (DTCMPSEL = 0) for dead-time compensation.

#### Affected Silicon Revisions

A0							
X							

## 7. Module: UART

When the UART is operating with STSEL<1:0> = 2 (two Stop bits sent, two checked at receive) and STPMD = 0, the FERR bit will not get set if one Stop bit is received.

### Work around

Use STPSEL = 3 instead of STSEL = 2. When operating with STSEL = 3 mode, the UART will be configured to send two Stop bits, but check one at receive.

### Affected Silicon Revisions

A0							
X							

## 8. Module: UART

When the receive buffer overflows, the 9th byte received will get lost and cannot be read.

### Work around

Do not allow the OERR bit to get set by reading the received data byte on each byte reception.

### Affected Silicon Revisions

A0							
X							

## 9. Module: UART

Once the TX Write Transmit Error Status bit (TXWRE, UxSTAH<7>) gets set, the TXWRE bit cannot be cleared by a single clear instruction.

### Work around

Use multiple clear instructions in a loop until the TXWRE bit gets cleared.

### Affected Silicon Revisions

A0							
X							

## 10. Module: UART

In UART Address Detect mode, writing to UxP1 with UTXBRK = 1 should cause a Break to be transmitted, followed by the content in P1, but the content of P1 will not get transmitted.

### Work around

After writing to P1, wait for UTXBRK to get clear and then rewrite to P1.

### Affected Silicon Revisions

A0							
X							

## 11. Module: UART

In Address Detect mode, the content of P1 is not transmitted on writing to P1 with UTXBRK = 1.

### Work around

Write P1 a second time after waiting for the Break transmission to start.

### Affected Silicon Revisions

A0							
X							

## 12. Module: UART

When waking from Sleep with a UART reception, SLPEN needs to be set in addition to WAKE = 1.

### Work around

Set SLPEN bit in addition to WAKE before entering Sleep.

### Affected Silicon Revisions

A0							
X							

**13. Module: UART**

In Smart Card T = 1 mode, the Wait time interrupt flag is set when the last character transmitted has the bit, LAST = 0.

**Work around**

Ignore WTC interrupt events on non-last bytes.

**Affected Silicon Revisions**

A0							
X							

**14. Module: MBIST**

After a Reset, the MBISTDONE status bit will be set regardless of a BIST test being executed. If a BIST is requested and executed, the MBISTDONE bit will set as expected.

**Work around**

None.

**Affected Silicon Revisions**

A0							
X							

**15. Module: CPU**

The FLIM instruction may incorrectly limit the data range when operating on signed operands of different sign values. If the operands are either all negative or all positive, the limit is correct.

**Work around**

None.

**Affected Silicon Revisions**

A0							
X							

**16. Module: CPU**

When operating on signed operands of different sign values, the output for MAXAB, MINAB and MINZAB instructions may be incorrect. If the operands are either all negative or all positive, the output is correct.

**Work around**

None.

**Affected Silicon Revisions**

A0							
X							

**17. Module: CPU**

When using the Signed 32-by-16-Bit Division instruction, `div.sd`, the Overflow bit may not always get set when an overflow occurs. This erratum only affects operations in which at least one of the following conditions is true:

- Dividend and divisor differ in sign,
- Dividend > 0x3FFFFFFF or
- Dividend < 0xC0000000

**Work around**

The application software must perform both the following actions to handle possible undetected overflow conditions:

- The value of the dividend must always be constrained to be in the following range:  
 $0xC0000000 \leq \text{Dividend} \leq 0x3FFFFFFF$ .
- If the dividend and divisor differ in sign (e.g., dividend is negative and divisor is positive), then after executing the `div.sd` instruction or the compiler built-in function, `__builtin_divsd()`, inspect the sign of the resultant quotient. If the quotient is found to be a positive number, then treat it as an overflow condition.

**Affected Silicon Revisions**

A0							
X							

**18. Module: CPU**

When using Byte mode instructions, the upper byte of the destination register may not be persistent.

**Work around**

None.

**Affected Silicon Revisions**

A0							
X							

# dsPIC33CH512MP508

## 19. Module: SCCP/MCCP

When Fosc is selected as the clock source using the CLKSEL<2:0> bits (CCPxCON1L<10:8>), unexpected operation may occur. For proper SCCP/MCCP input clock synchronization, do not use Fosc as the CCP clock source.

### Work around

Use any of the other available clock sources in CLKSEL<2:0>.

### Affected Silicon Revisions

A0							
X							

## 20. Module: I/O

At device power-up, the I/O pins may drive a pulse up to 0.8V for a duration of up to 100 µSec.

### Work around

Ensure the circuitry that is connected to the pins can endure this active duration.

Example applications affected may include complementary power switches, where a transient current shoot-through might occur. High-voltage applications with complementary switches should power the high-voltage 200 µSec later than powering the dsPIC® device to avoid the issue. The behavior is specific to each part and consistent for that part. It is not affected by aging.

### Affected Silicon Revisions

A0							
X							



## Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS70005371**B**):

<b>Note:</b> Corrections are shown in <b>bold</b> . Where possible, the original bold text formatting has been removed for clarity.
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None.

## APPENDIX A: DOCUMENT REVISION HISTORY

Rev A Document (10/2018)

Initial version of this document; issued for revision A0.

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